**FEATURES**
- 80 MHz Pipelined Operation
- Triple 8-Bit D/A Converters
- RS-343A/RS-170 Compatible Outputs
- TTL Compatible Inputs
- +5 V CMOS Monolithic Construction
- 40-Pin DIP or 44-Pin PLCC Package
- Plug-In Replacement for BT101
- Power Dissipation: 400 mW

**APPLICATIONS**
- High Resolution Color Graphics
- CAE/CAD/CAM Applications
- Image Processing
- Instrumentation
- Video Signal Reconstruction
- Desktop Publishing

**SPEED GRADES**
- 80 MHz
- 50 MHz
- 30 MHz

**GENERAL DESCRIPTION**
The ADV101 is a digital-to-analog video converter on a single monolithic chip. The part is specifically designed for high resolution color graphics and video systems. It consists of three, high speed, 8-bit, video D/A converters (RGB); a standard TTL input interface and high impedance, analog output, current sources.

The ADV101 has three separate, 8-bit, pixel input ports, one each for red, green and blue video data. Additional video input controls on the part include sync, blank and reference white. A single +5 V supply, an external 1.23 V reference and pixel clock input are all that are required to make the part operational.

The ADV101 is capable of generating RGB video output signals, which are compatible with RS-343A and RS-170 video standards, without requiring external buffering.

The ADV101 is fabricated in a +5 V CMOS process. Its monolithic CMOS construction ensures greater functionality with low power dissipation. The part is packaged in both a 0.6", 40-pin plastic DIP and a 44-pin plastic leaded (J-lead) chip carrier, PLCC.

*ADV is a registered trademark of Analog Devices Inc.*

**FUNCTIONAL BLOCK DIAGRAM**

**PRODUCT HIGHLIGHTS**
1. Fast video refresh rate, 80 MHz.
2. Compatible with a wide variety of high resolution color graphics video systems.
3. Guaranteed monotonic with a maximum differential nonlinearity of ±0.5 LSB. Integral nonlinearity is guaranteed to be a maximum of ±1 LSB.
### ADV101- SPECIFICATIONS

\( V_{\text{AA}} = +5 \, \text{V} \pm 5\%; \ V_{\text{REF}} = +1.235 \, \text{V}; \ R_L = 37.5 \, \Omega; \ C_L = 10 \, \text{pF}; \ R_{\text{SET}} = 560 \, \Omega. \) \( I_{\text{SYNC}} \) connected to IOG. All Specifications \( T_{\text{MIN}} \) to \( T_{\text{MAX}} \) unless otherwise noted.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>All Versions</th>
<th>Units</th>
<th>Test Conditions/Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>STATIC PERFORMANCE</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Resolution (Each DAC)</td>
<td>8</td>
<td>Bits</td>
<td></td>
</tr>
<tr>
<td>Accuracy (Each DAC)</td>
<td>±1</td>
<td>LSB max</td>
<td></td>
</tr>
<tr>
<td>Integral Nonlinearity, INL</td>
<td>±0.5</td>
<td>LSB max</td>
<td>Guaranteed M onotonic</td>
</tr>
<tr>
<td>Differential Nonlinearity, DNL</td>
<td>±5</td>
<td>% Gray Scale max</td>
<td>Max Gray Scale Current: ( I_{\text{OOG}} = \left( V_{\text{REF}} \times \frac{12,082}{R_{\text{SET}}} \right) ) mA ( I_{\text{OR}}, I_{\text{OB}} = \left( V_{\text{REF}} \times \frac{8,627}{R_{\text{SET}}} \right) ) mA</td>
</tr>
<tr>
<td>Coding</td>
<td>Binary</td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>DIGITAL INPUTS</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input High Voltage, ( V_{\text{INH}} )</td>
<td>2</td>
<td>V min</td>
<td></td>
</tr>
<tr>
<td>Input Low Voltage, ( V_{\text{INL}} )</td>
<td>0.8</td>
<td>V max</td>
<td></td>
</tr>
<tr>
<td>Input Current, ( I_{\text{IN}} )</td>
<td>±1</td>
<td>( \mu )A max</td>
<td>( V_{\text{IN}} = 0.4 , \text{V} ) or ( 2.4 , \text{V} )</td>
</tr>
<tr>
<td>Input Capacitance, ( C_{\text{IN}} )</td>
<td>10</td>
<td>pF max</td>
<td></td>
</tr>
<tr>
<td><strong>ANALOG OUTPUTS</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Gray Scale Current Range</td>
<td>15</td>
<td>mA min</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>22</td>
<td>mA max</td>
</tr>
<tr>
<td>Output Current</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>White Level Relative to Blank</td>
<td>17.69</td>
<td>mA min</td>
<td>Typically 19.05 mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td>20.40</td>
<td>mA max</td>
</tr>
<tr>
<td>White Level Relative to Black</td>
<td>16.74</td>
<td>mA min</td>
<td>Typically 17.62 mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td>18.50</td>
<td>mA max</td>
</tr>
<tr>
<td>Black Level Relative to Blank</td>
<td>0.95</td>
<td>mA min</td>
<td>Typically 1.44 mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td>1.90</td>
<td>mA max</td>
</tr>
<tr>
<td>Blank Level on IOR, IOB</td>
<td>0</td>
<td>( \mu )A min</td>
<td>Typically 5 ( \mu )A</td>
</tr>
<tr>
<td></td>
<td></td>
<td>50</td>
<td>( \mu )A max</td>
</tr>
<tr>
<td>Blank Level on IOG</td>
<td>6.29</td>
<td>mA min</td>
<td>Typically 7.62 mA</td>
</tr>
<tr>
<td></td>
<td></td>
<td>9.5</td>
<td>mA max</td>
</tr>
<tr>
<td>Sync Level on IOG</td>
<td>0</td>
<td>( \mu )A min</td>
<td>Typically 5 ( \mu )A</td>
</tr>
<tr>
<td></td>
<td></td>
<td>50</td>
<td>( \mu )A max</td>
</tr>
<tr>
<td>LSB Size</td>
<td>69.1</td>
<td>( \mu )A typ</td>
<td></td>
</tr>
<tr>
<td>DAC to DAC M atching</td>
<td>2</td>
<td>% typ</td>
<td></td>
</tr>
<tr>
<td>Output Compliance, ( V_{\text{OC}} )</td>
<td>-1</td>
<td>V min</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>+1.4</td>
<td>V max</td>
</tr>
<tr>
<td>Output Impedance, ( R_{\text{OUT}} )</td>
<td>100</td>
<td>k( \Omega ) typ</td>
<td></td>
</tr>
<tr>
<td>Output Capacitance, ( C_{\text{OUT}} )</td>
<td>30</td>
<td>pF max</td>
<td></td>
</tr>
<tr>
<td><strong>VOLTAGE REFERENCE</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Voltage Reference Range, ( V_{\text{REF}} )</td>
<td>1.14/1.26</td>
<td>V min/V max</td>
<td>( V_{\text{REF}} = 1.235 , \text{V} ) for Specified Performance</td>
</tr>
<tr>
<td>Input Current, ( I_{\text{REF}} )</td>
<td>+10</td>
<td>( \mu )A typ</td>
<td></td>
</tr>
<tr>
<td><strong>POWER REQUIREMENTS</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>( V_{\text{AA}} )</td>
<td>5</td>
<td>V nom</td>
<td>Typically 80 mA: 80 M Hz Parts</td>
</tr>
<tr>
<td>( I_{\text{AA}} )</td>
<td>125</td>
<td>mA max</td>
<td>Typically 70 mA: 50 M Hz &amp; 35 M Hz Parts</td>
</tr>
<tr>
<td></td>
<td>100</td>
<td>mA max</td>
<td></td>
</tr>
<tr>
<td>Power Supply Rejection Ratio</td>
<td>0.5</td>
<td>%/% max</td>
<td>Typically 0.12%/%: ( f = 1 , \text{kHz} ), ( \text{COM} , \text{P} = 0.1 , \mu \text{F} )</td>
</tr>
<tr>
<td>Power Dissipation</td>
<td>625</td>
<td>mW max</td>
<td>Typically 400 mW: 80 M Hz Parts</td>
</tr>
<tr>
<td></td>
<td>500</td>
<td>mW max</td>
<td>Typically 350 mW: 50 M Hz &amp; 30 M Hz Parts</td>
</tr>
<tr>
<td><strong>DYNAMIC PERFORMANCE</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Glitch Impulse(^2,3)</td>
<td>50</td>
<td>pV secs typ</td>
<td></td>
</tr>
<tr>
<td>DAC Noise(^2,3,4)</td>
<td>200</td>
<td>pV secs typ</td>
<td></td>
</tr>
<tr>
<td>Analog Output Skew</td>
<td>2</td>
<td>ns max</td>
<td>Typically 1 ns</td>
</tr>
</tbody>
</table>

**NOTES**

1. Temperature Range (\( T_{\text{MIN}} \) to \( T_{\text{MAX}} \)): 0°C to +70°C.
2. Sample tested at +25°C to ensure compliance.
3. TTL input values are 0 to 3 volts, with input rise/fall times \( \leq 3 \, \text{ns} \), measured between the 10% and 90% points. Timing reference points at 50% for inputs and outputs. See timing notes in Figure 1.
4. This includes effects due to clock and data feedthrough as well as RGB analog crosstalk.

Specifications subject to change without notice.
### TIMING CHARACTERISTICS

\( V_{\text{AA}} = +5 \, \text{V} \pm 5\% ; \; V_{\text{REF}} = +1.235 \, \text{V} ; \; R_L = 37.5 \, \text{\Omega} ; \; C_L = 10 \, \text{pF} ; \; R_{\text{SET}} = 560 \, \text{\Omega} \).

\( I_{\text{SYNC}} \) connected to \( 10 \, \text{G} \). All Specifications \( T_{\text{MIN}} \) to \( T_{\text{MAX}} \) unless otherwise noted.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>80 MHz Version</th>
<th>50 MHz Version</th>
<th>30 MHz Version</th>
<th>Conditions/Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td>( f_{\text{MAX}} )</td>
<td>80 MHz max</td>
<td>50 MHz max</td>
<td>30 MHz max</td>
<td>Clock Rate</td>
</tr>
<tr>
<td>( t_1 )</td>
<td>3 ns min</td>
<td>6 ns min</td>
<td>8 ns min</td>
<td>Data &amp; Control Setup Time</td>
</tr>
<tr>
<td>( t_2 )</td>
<td>2 ns min</td>
<td>2 ns min</td>
<td>2 ns min</td>
<td>Data &amp; Control Hold Time</td>
</tr>
<tr>
<td>( t_3 )</td>
<td>12.5 ns min</td>
<td>20 ns min</td>
<td>33.3 ns min</td>
<td>Clock Cycle Time</td>
</tr>
<tr>
<td>( t_4 )</td>
<td>4 ns min</td>
<td>7 ns min</td>
<td>9 ns min</td>
<td>Clock Pulse Width High Time</td>
</tr>
<tr>
<td>( t_5 )</td>
<td>4 ns min</td>
<td>7 ns min</td>
<td>9 ns min</td>
<td>Clock Pulse Width Low Time</td>
</tr>
<tr>
<td>( t_6 )</td>
<td>30 ns max</td>
<td>30 ns max</td>
<td>30 ns max</td>
<td>Analog Output Delay</td>
</tr>
<tr>
<td>( t_7 )</td>
<td>3 ns max</td>
<td>3 ns max</td>
<td>3 ns max</td>
<td>Analog Output Rise/Fall Time</td>
</tr>
<tr>
<td>( t_8 )</td>
<td>15 ns typ</td>
<td>15 ns typ</td>
<td>15 ns typ</td>
<td>Analog Output Transition Time</td>
</tr>
</tbody>
</table>

**NOTES**

1. TTL input values are 0 to 3 volts, with input rise/fall times \( \leq 3 \, \text{ns} \), measured between the 10% and 90% points. Timing reference points at 50% for inputs and outputs. See timing notes in Figure 1.

2. Temperature range \( (T_{\text{MIN}} \) to \( T_{\text{MAX}}) : 0 \, ^{\circ}C \) to \( +70 \, ^{\circ}C \).

3. Sample tested at \( +25 \, ^{\circ}C \) to ensure compliance.

Specifications subject to change without notice.

---

**Figure 1. Video Input/Output Timing**
WARNING!
ESD SENSITIVE DEVICE

CAUTION
ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADV101 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

ABSOLUTE MAXIMUM RATINGS

V_{AA} to GND ........................................ +7 V
Voltage on Any Digital Pin .................. GND - 0.5 V to V_{AA} + 0.5 V
Ambient Operating Temperature (T_{A}) .......... 0°C to +70°C
Storage Temperature (T_{S}) .................... -65°C to +150°C
Junction Temperature (T_{J}) .................. +150°C
Soldering Temperature (10 secs) ................. 300°C
Vapor Phase Soldering (1 minute) .................. 220°C
I_{OR}, I_{OB}, I_{OG}, I_{SYNC} to GND2 .......... 0 V to V_{AA}

NOTES
1Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
2Analog output short circuit to any power supply or common can be of an indefinite duration.

ORDERING GUIDE

Package Speed

<table>
<thead>
<tr>
<th>Package Type</th>
<th>80 MHz</th>
<th>50 MHz</th>
<th>30 MHz</th>
</tr>
</thead>
<tbody>
<tr>
<td>Plastic DIP</td>
<td>ADV101KN80</td>
<td>ADV101KN50</td>
<td>ADV101KN30</td>
</tr>
<tr>
<td>PLCC3</td>
<td>ADV101KP80</td>
<td>ADV101KP50</td>
<td>ADV101KP30</td>
</tr>
</tbody>
</table>

NOTES
1All devices are specified for 0°C to +70°C operation.
2N = Plastic DIP; P = Plastic Leaded Chip Carrier.
3PLCC: Plastic Leaded Chip Carrier (J-lead).

PIN CONFIGURATIONS
## PIN FUNCTION DESCRIPTION

<table>
<thead>
<tr>
<th>Pin Mnemonic</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>BLANK</td>
<td>Composite blank control input (TTL compatible). A logic zero on this control input drives the analog outputs, IOR, IOB and IOG, to the blanking level. The BLANK signal is latched on the rising edge of CLOCK. While BLANK is a logical zero, the R0–R7, G0–G7, R0–R7 and REF WHITE pixel and control inputs are ignored.</td>
</tr>
<tr>
<td>SYNC</td>
<td>Composite sync control input (TTL compatible). A logical zero on the SYNC input; switches off a 40 IRE current source on the ISYNC output. SYNC does not override any other control or data input, therefore, it should only be asserted during the blanking interval. SYNC is latched on the rising edge of CLOCK.</td>
</tr>
<tr>
<td>CLOCK</td>
<td>Clock input (TTL compatible). The rising edge of CLOCK latches the R0–R7, G0–G7, B0–B7, SYNC, BLANK and REF WHITE pixel and control inputs. It is typically the pixel clock rate of the video system. CLOCK should be driven by a dedicated TTL buffer.</td>
</tr>
<tr>
<td>REF WHITE</td>
<td>Reference white control input (TTL compatible). A logical one on this input forces the IOR, IOG and IOB outputs to the white level, regardless of the pixel input data (R0–R7, G0–G7 and B0–B7) REF WHITE is latched on the rising edge of clock.</td>
</tr>
<tr>
<td>R0–R7, G0–G7, B0–B7</td>
<td>Red, green and blue pixel data inputs (TTL compatible). Pixel data is latched on the rising edge of CLOCK. R0, G0 and B0 are the least significant data bits. Unused pixel data inputs should be connected to either the regular PCB power or ground plane.</td>
</tr>
<tr>
<td>IOR, IOG, IOB</td>
<td>Red, green and blue current outputs. These high impedance current sources are capable of directly driving a doubly terminated 75 Ω coaxial cable. All three current outputs should have similar output loads whether or not they are all being used.</td>
</tr>
</tbody>
</table>
| ISYNC        | Sync current output. This high impedance current source can be directly connected to the IOG output. This allows sync information to be encoded onto the green channel. ISYNC does not output any current while SYNC is at logical zero. The amount of current output at ISYNC while SYNC is at logical one is given by:  

\[
I_{SYNC} \text{ (mA)} = 3,455 \times V_{REF} \text{ (V)} / R_{SET} \text{ (Ω)}
\]

If sync information is not required on the green channel, ISYNC should be connected to AGND. |
| FS ADJUST    | Full-scale adjust control. A resistor (RSET) connected between this pin and GND, controls the magnitude of the full-scale video signal. Note that the IRE relationships are maintained, regardless of the full-scale output current. The relationship between RSET and the full-scale output current on IOG (assuming ISYNC is connected to IOG) is given by:  

\[
R_{SET} \text{ (Ω)} = 12,082 \times V_{REF} \text{ (V)} / I_{OG} \text{ (mA)}
\]

The relationship between RSET and the full-scale output current on IOR and IOB is given by:  

\[
I_{OR, IOB} \text{ (mA)} = 8,628 \times V_{REF} \text{ (V)} / R_{SET} \text{ (Ω)}
\]
| COM P        | Compensation pin. This is a compensation pin for the internal reference amplifier. A 0.1 μF ceramic capacitor must be connected between COM P and VAA. |
| VREF         | Voltage reference input. An external 1.2 V voltage reference must be connected to this pin. The use of an external resistor divider network is not recommended. A 0.1 μF decoupling ceramic capacitor should be connected between VREF and VAA. |
| VAA          | Analog power supply (5 V ± 5%). All VAA pins on the ADV101 must be connected. |
| GND          | Ground. All GND pins must be connected. |
**TERMINOLOGY**

**Blanking Level**
The level separating the Sync portion from the video portion of the waveform. Usually referred to as the front porch or back porch. At 0 IRE units, it is the level which will shut off the picture tube, resulting in the blackest possible picture.

**Color Video (RGB)**
This usually refers to the technique of combining the three primary colors of red, green and blue to produce color pictures within the usual spectrum. In RGB monitors, three DACs are required, one for each color.

**Sync Signal (SYNC)**
The position of the composite video signal which synchronizes the scanning process.

**Gray Scale**
The discrete levels of video signal between reference black and reference white levels. An 8-bit DAC contains 256 different levels, while a 6-bit DAC contains 64.

**CIRCUIT DESCRIPTION AND OPERATION**
The ADV101 contains three 8-bit D/A converters, with three input channels, each containing an 8-bit register. Also integrated on board the part is a reference amplifier and CRT control functions BLANK, SYNC and REF WHITE.

**Digital Inputs**
24-bits of pixel data (color information) R0–R7, G0–G7 and B0–B7 are latched into the device on the rising edge of each clock cycle. This data is presented to the three 8-bit DACs and is then converted to three analog (RGB) output waveforms. (See Figure 2.)

Three other digital control signals are latched to the analog video outputs in a similar fashion. BLANK, SYNC and REF WHITE are each latched on the rising edge of CLOCK to maintain synchronization with the pixel data stream.

The BLANK and SYNC functions allow for the encoding of these video synchronization signals onto the RGB video output. This is done by adding appropriately weighted current sources to the analog outputs, as determined by the logic levels on the BLANK and SYNC digital inputs. Figure 3 shows the analog output, RGB video waveform of the ADV101. The influence of SYNC and BLANK on the analog video waveform is illustrated.

The REF WHITE control input drives the RGB video outputs to the white level. This function could be used to overlay a cursor or crosshair onto the RGB video output.

Table I details the resultant effect on the analog outputs of BLANK, SYNC and REF WHITE.

All these digital inputs are specified to accept TTL logic levels.

**Clock Input**
The CLOCK input of the ADV101 is typically the pixel clock rate of the system. It is also known as the dot rate. The dot rate and hence the required CLOCK frequency, will be determined by the on-screen resolution, according to the following equation.

\[
\text{Dot Rate} = \frac{(\text{Horiz Res}) \times (\text{Vert Res}) \times (\text{Refresh Rate})}{(1 - \text{Retrace Factor})}
\]

- Horiz Res = Number of pixels/line
- Vert Res = Number of lines/frame
- Refresh Rate = Horizontal Scan Rate. This is the rate at which the screen must be refreshed, typically 60 Hz for a noninterlaced system or 30 Hz for an interlaced system.
- Retrace Factor = Total blank time factor. This takes into account that the display is blanked for a certain fraction of the total duration of each frame (e.g., 0.8).

The REF WHITE control input drives the RGB video outputs to the white level. This function could be used to overlay a cursor or crosshair onto the RGB video output.

**Table I**

<table>
<thead>
<tr>
<th>Digital Input</th>
<th>Analog Output Effect</th>
</tr>
</thead>
<tbody>
<tr>
<td>BLANK</td>
<td></td>
</tr>
<tr>
<td>Sync</td>
<td></td>
</tr>
<tr>
<td>Ref White</td>
<td></td>
</tr>
</tbody>
</table>

**Raster Scan**
The most basic method of sweeping a CRT one line at a time to generate and display images.

**Reference Black Level**
The maximum negative polarity amplitude of the video signal.

**Reference White Level**
The maximum positive polarity amplitude of the video signal.

**Sync Level**
The peak level of the SYNC signal.

**Video Signal**
That portion of the composite video signal which varies in gray scale levels between reference white and reference black. Also referred to as the picture signal, this is the portion which may be visually observed.

---

Figure 2. Video Data Input/Output
If we, therefore, have a graphics system with a 1024 × 1024 resolution, a noninterlaced 60 Hz refresh rate and a retrace factor of 0.8, then:

\[
\text{Dot Rate} = \frac{1024 \times 1024 \times 60}{0.8} = 78.6 \text{ MHz}
\]

The required CLOCK frequency is thus 78.6 MHz.

All video data and control inputs are latched into the ADV101 on the rising edge of CLOCK, as previously described in the “Digital Inputs” section. It is recommended that the CLOCK input to the ADV101 be driven by a TTL buffer (e.g., 74F244).

**Video Synchronization and Control**

The ADV101 has a single composite video sync (SYNC) input control. Many graphics processors and CRT controllers have the ability of generating horizontal sync (H_SYNC), vertical sync (V_SYNC) and composite SYNC.

In a graphics system which does not automatically generate a composite SYNC signal, the inclusion of some additional logic circuitry will enable the generation of a composite SYNC signal.

The ISYNC current output is typically connected directly to the IOG output, thus encoding video synchronization information onto the green video channel. If it is not required to encode sync information onto the ADV101, the SYNC input should be tied to logic low and ISYNC should be connected to analog GND.

**Reference Input**

An external 1.23 V voltage reference is required to drive the ADV101. The AD589 from Analog Devices is an ideal choice of reference. It is a two-terminal, low cost, temperature compensated bandgap voltage reference which provides a fixed 1.23 V output voltage for input currents between 50 µA and 5 mA. Figure 4 shows a typical reference circuit connection diagram. The voltage reference gets its current drive from the ADV101’s VAA through an external 1 kΩ resistor to the V_REF pin. A 0.1 µF ceramic capacitor is required between the COMP and V AA. This is necessary so as to provide compensation for the internal reference amplifier.
ADV101

A resistance $R_{SET}$ connected between FS ADJUST and GND determines the amplitude of the output video level according to the following equations:

$$IOG (mA) = 12,082 \times \frac{V_{REF} (V)}{R_{SET} (\Omega)}$$ (1)

$$IOR, IOB (mA) = 8,628 \times \frac{V_{REF} (V)}{R_{SET} (\Omega)}$$ (2)

If $SYNC$ is not being encoded onto the green channel, then Equation 1 will be similar to Equation 2.

Using a variable value of $R_{SET}$, as shown in Figure 4, allows for accurate adjustment of the analog output video levels. Use of a fixed 560 $\Omega$ $R_{SET}$ resistor yields the analog output levels as quoted in the specification page. These values also correspond to the RS-343A video waveform values as shown in Figure 3.

**Figure 4. Reference Circuit**

**D/A Converters**

The ADV101 contains three matched 8-bit D/A converters. The DACs are designed using an advanced, high speed, segmented architecture. The bit currents corresponding to each digital input are routed to either the analog output (bit = “1”) or GND (bit = “0”) by a sophisticated decoding scheme. As all this circuitry is on one monolithic device, matching between the three DACs is optimized. As well as matching, the use of identical current sources in a monolithic design guarantees monotonicity and low glitch. The onboard operational amplifier stabilizes the full-scale output current against temperature and power supply variations.

**Analog Outputs**

The ADV101 has three analog outputs, corresponding to the red, green and blue video signals. A fourth analog output ($I_{SYNC}$) can be used if it is required to encode video synchronization information onto the green signal. In this case, $I_{SYNC}$ is connected to IOG. (See “Video Synchronization and Control” section.)

The red, green and blue analog outputs of the ADV101 are high impedance current sources. Each one of these three RGB current outputs is capable of directly driving a 37.5 $\Omega$ load, such as a doubly terminated 75 $\Omega$ coaxial cable. Figure 5a shows the required configuration for each of the three RGB outputs connected into a doubly terminated 75 $\Omega$ load. This arrangement will develop RS-343A video output voltage levels across a 75 $\Omega$ monitor.

A suggested method of driving RS-170 video levels into a 75 $\Omega$ monitor is shown in Figure 5b. The output current levels of the DACs remain unchanged, but the source termination resistance, $Z_S$, on each of the three DACs is increased from 75 $\Omega$ to 150 $\Omega$.

More detailed information regarding load terminations for various output configurations, including RS-343A and RS-170, is available in an application note entitled “Video Formats & Required Load Terminations” available from Analog Devices, publication number E1228-15-1/89.

Figure 3 shows the video waveforms associated with the three RGB outputs driving the doubly terminated 75 $\Omega$ load of Figure 5a. As well as the gray scale levels, black level to white level, the diagram also shows the contributions of $SYNC$ and $BLANK$. These control inputs add appropriately weighted currents to the analog outputs, producing the specific output level requirements for video applications. Table I details how the $SYNC$ and $BLANK$ inputs modify the output levels.

**Gray Scale Operation**

The ADV101 can be used for stand-alone, gray scale (monochrome) or composite video applications (i.e., only one channel used for video information). Any one of the three channels, red, green or blue can be used to input the digital video data. The two unused video data channels should be tied to logical zero.
The unused analog outputs should be terminated with the same load as that for the used channel. In other words, if the red channel is used and IOR is terminated with a doubly terminated 75 Ω load (37.5 Ω), IOB and IOG should be terminated with 37.5 Ω resistors. (See Figure 6.)

**Figure 6. Input and Output Connections for Stand-Alone Gray Scale or Composite Video**

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**Video Output Buffers**

The ADV101 is specified to drive transmission line loads, which is what most monitors are rated as. The analog output configurations to drive such loads are described in the Analog Interface section and illustrated in Figure 5. However, in some applications it may be required to drive long “transmission line” cable lengths. Cable lengths greater than 10 meters can attenuate and distort high frequency analog output pulses. The inclusion of output buffers will compensate for some cable distortion. Buffers with large full power bandwidths and gains between 2 and 4 will be required. These buffers will also need to be able to supply sufficient current over the complete output voltage swing. Analog Devices produces a range of suitable op amps for such applications. These include the AD84X series of monolithic op amps. In very high frequency applications (80 MHz), the AD9617 is recommended. More information on line driver buffering circuits is given in the relevant op amp data sheets.

Use of buffer amplifiers also allows implementation of other video standards besides RS-343A and RS-170. Altering the gain components of the buffer circuit will result in any desired video level.

**Figure 7. AD848 As an Output Buffer**
The ADV101 is optimally designed for lowest noise performance, both radiated and conducted noise. To complement the excellent noise performance of the ADV101, it is imperative that great care be given to the PC board layout. Figure 8 shows a recommended connection diagram for the ADV101.

The layout should be optimized for lowest noise on the ADV101 power and ground lines. This can be achieved by shielding the digital inputs and providing good decoupling. The lead length between groups of \( V_{AA} \) and GND pins should be minimized so as to minimize inductive ringing.

**Ground Planes**

The ADV101, and associated analog circuitry, should have a separate ground plane referred to as the analog ground plane. This ground plane should connect to the regular PCB ground plane at a single point through a ferrite bead, as illustrated in Figure 8. This bead should be located as close as possible (within 3 inches) to the ADV101.

The analog ground plane should encompass all ADV101 ground pins, voltage reference circuitry, power supply bypass circuitry, the analog output traces and any output amplifiers.

The regular PCB ground plane area should encompass all the digital signal traces, excluding the ground pins, leading up to the ADV101.

**Figure 8. Typical Connection Diagram and Component List**
Power Planes
The PC board layout should have two distinct power planes, one for analog circuitry and one for digital circuitry. The analog power plane should encompass the ADV101 (V_{AA}) and all associated analog circuitry. This power plane should be connected to the regular PCB power plane (V_{CC}) at a single point through a ferrite bead, as illustrated in Figure 8. This bead should be located within three inches of the ADV101.

The PCB power plane should provide power to all digital logic on the PC board, and the analog power plane should provide power to all ADV101 power pins, voltage reference circuitry and any output amplifiers.

The PCB power and ground planes should not overlay portions of the analog power plane. Keeping the PCB power and ground planes from overlaying the analog power plane will contribute to a reduction in plane-to-plane noise coupling.

Supply Decoupling
Noise on the analog power plane can be further reduced by the use of multiple decoupling capacitors. (See Figure 8.)

Optimum performance is achieved by the use of 0.1 µF ceramic capacitors. Each of the two groups of V_{AA} should be individually decoupled to ground. This should be done by placing the capacitors as close as possible to the device with the capacitor leads as short as possible, thus minimizing lead inductance.

It is important to note that while the ADV101 contains circuitry to reject power supply noise, this rejection decreases with frequency. If a high frequency switching power supply is used, the designer should pay close attention to reducing power supply noise. A dc power supply filter (Murata BNX002) will provide EMI suppression between the switching power supply and the main PCB. Alternatively, consideration could be given to using a three-terminal voltage regulator.

Digital Signal Interconnect
The digital signal lines to the ADV101 should be isolated as much as possible from the analog outputs and other analog circuitry. Digital signal lines should not overlay the analog power plane.

Due to the high clock rates used, long clock lines to the ADV101 should be avoided so as to minimize noise pickup.

Any active pull-up termination resistors for the digital inputs should be connected to the regular PCB power plane (V_{CC}), and not the analog power plane.

Analog Signal Interconnect
The ADV101 should be located as close as possible to the output connectors thus minimizing noise pickup and reflections due to impedance mismatch.

The video output signals should overlay the ground plane, and not the analog power plane, thereby maximizing the high frequency power supply rejection.

For optimum performance, the analog outputs should each have a source termination resistance to ground of 75 Ω (doubly terminated 75 Ω configuration). This termination resistance should be as close as possible to the ADV101 so as to minimize reflections.

Additional information on PCB design is available in an application note entitled “Design and Layout of a Video Graphics System for Reduced EMI.” This application note is available from Analog Devices, publication number E1309–15–10/89.
OUTLINE DIMENSIONS
Dimensions shown in inches and (mm).

44-Terminal Plastic Leaded Chip Carrier
(P-44A)

40-Pin Plastic DIP
(N-40A)

LEAD NO. 1 IDENTIFIED BY DOT, NOTCH OR "1."
LEADS ARE SOLDER PLATED KOVAR OR ALLOY 42.